

Commission Delegated Directive 2014/5/EU of 18 October 2013 amending, for the purposes of adapting to technical progress, Annex IV to Directive 2011/65/EU of the European Parliament and of the Council as regards an exemption for lead in solders on printed circuit boards, termination coatings of electrical and electronic components and coatings of printed circuit boards, solders for connecting wires and cables, solders connecting transducers and sensors that are used durably at a temperature below – 20 °C under normal operating and storage conditions (Text with EEA relevance)

- Article 1 Annex IV to Directive 2011/65/EU is amended as set out...
- Article 2 (1) Member States shall bring into force the laws, regulations...
- Article 3 This Directive shall enter into force on the twentieth day...
- Article 4 This Directive is addressed to the Member States.  
Signature

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#### ANNEX

In Annex IV to Directive 2011/65/EU the following point 26...  
26. Lead in solders on printed circuit boards, termination coatings...

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**Status:** EU Directives are being published on this site to aid cross referencing from UK legislation. After  
IP completion day (31 December 2020 11pm) no further amendments will be applied to this version.

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- (1) [OJ L 174, 1.7.2011, p. 88.](#)